Intel Innovations Re-Imagining Data Center Storage and Memory March 2018

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Re-Imagining Data Center Storage and Memory with Intel Innovations

YESTERDAY—		TODAY —
Network		Network
Compute Storage	Scalable Server Racks Enabled by Intel Innovation	Compute Intel [®] Optane [™] Technology
Compute Storage		Compute Intel® Optane TM Technology
Compute Storage		Compute Intel® Optane™ Technology
Compute Storage		Compute Intel® Optane™ Technology
Compute Storage		Compute Intel® Optane M Technology
Compute Storage		Compute Intel® Optane™ Technology
Compute Storage		Bulk Storage
Compute Storage		Bulk Storage
Compute Storage		Bulk Storage
Rack		Rack



Intel[®] Storage and Memory Innovations A Range of Solutions for Today's OCP Platforms



¹Tioga Pass and Glacier Point – Based on OCP Yosemite V.2 specification 0.4 <u>http://files.opencompute.org/oc/public.php?service=files&t=837133ef9167e70d79ba57450eccb826</u> ²Lightning – Based on OCP Lightning v1.0 specification <u>http://www.opencompute.org/wiki/Storage</u> * Product available at a later date. Check Intel roadmap for more details.



Intel Storage and Memory Innovations Building Blocks for Next Generation OCP Platforms

Platform Connected

- Manage more efficiently at scale
 - Accelerate apps
 - Simplify systems

Intel[®] 3D NAND Technology

- Industry leading areal density¹
- Massive, cost effective capacities

EDSFF 1U Long and 1U Short

Space, thermal, operationally efficient
Ready for PCIe* 4.0 and 5.0



"Apache Pass" DIMMs

- Big, affordable, persistent memory
- Available on future Intel[®] Xeon[®] processor based platforms

Intel[®] Optane[™] SSDs

- Massive, affordable memory extension
- Breakthrough cache bottleneck

¹Comparing areal density of Intel measured data on 512Gb Intel 3D NAND to representative competitors based on 2017 IEEE International Solid-State Circuits Conference papers citing Samsung Electronics and Western Digital/Toshiba die sizes for 64-stacked 3D NAND component. *Other names and brands may be claimed as the property of others.

NVM Solutions Group



Intel[®] Optane[™] SSD Most Responsive Data Center SSD in the World¹

Breakthrough Performance





Responsive Under Load



✓ up to 40x faster response under workload⁴

^{1, 2, 3, 4} See Appendix for specific configurations.



Polar DB* @Alibaba Breaking the Bottleneck with Intel[®] Optane[™] SSD

Workload Description

Alibaba is the largest e-commerce business in China and a rapidly growing cloud service provider. PolarDB* is their in-housedesigned transactional database. **Solution**

Alibaba designed a SDS scale-out system to journal on fast/low latency Intel[®] Optane[™] SSDs, data on low cost/high capacity Intel NVMe* SSDs.

Customer Value

This storage node solution reduces software and OS overhead, accelerating database performance to **improve Alibaba's customer shopping experience**.

Additional Info

- Solution consists of 3 replicas with one set for both read & write, and the other two set as read-only
- Previous solutions collocated journal and data on NAND-based Intel[®] SSD DC P3600
- 6x improvement⁵: 1 million QPS and 130K TPS, 120 seconds (vs 70 hours) for creating read-only replica, 360 seconds for fail-overs



Benchmark results were obtained prior to implementation of recent software patches and firmware updates intended to address exploits referred to as "Spectre" and "Meltdown". Implementation of these updates may make these results inapplicable to your device or system. ⁵Alibaba-tested, (See Appendix for source link) *Other names and brands may be claimed as the property of others.



POLARDB

Re-Imagining RAID NVMe* RAID built into CPU



^{6, 7, 8} See Appendix for Virtual RAID configuration and notes



Re-Imagining the Data Center Form Factor Enterprise Data Center SSD Form Factor (EDSFF)



EDSFF 1U Long



EDSFF 1U Short

1U Short and 1U Long Spec https://edsffspec.org/edsff-resources/ **Capacity Scaling.** up to 48 media sites 1U Long, 12 media sites 1U Short

Performance Scaling. x4, x8, x16 support

Future Ready. PCle* 4.0 and 5.0 ready

Thermal efficiency. up to 55% less airflow required than U.2 15mm¹

Solution Range. 10 Long, 10 Short, case, caseless designs.

¹EDSFF 1U Short spec. Source – EDSFF.org. <u>https://edsffspec.org/edsff-resources/</u>



EDSFF 1U Short (SFF-TA-1006¹) Best of U.2 and M.2



¹EDSFF 1U Short spec. Source – EDSFF.org. <u>https://edsffspec.org/edsff-resources/</u> *Other names and brands may be claimed as the property of others.



EDSFF. Re-Imagining JBOF.

PCIE* JBOF with M.2



PCIe* JBOF with EDSFF 1U Long



PCIe* M.2 flash card¹ **Design Objectives** EDSFF 1U Long² 256TB - 1PB³ Dense capacity **60TB** (32 slots, 8-32TB Intel[®] SSD DC P4510) (15 bays, 2 drives per bay, 2TB per drive) No cables No cables, Fully passive backplane, System simplification orthogonal connector Future-proof PCIe 3.0 only PCIe 4.0, 5.0 ready Thermal efficiency Top/bottom heatsinks + TIMs reg. **Optimal airflow** (drives in front, horizontal mid-plane) Serviceable 1. Pull tray, 2. Pull drive carrier, 3. Fully front serviceable Remove heatsink, 4. Remove SSD

¹Based on OCP Lightning v1.0 specification <u>http://www.opencompute.org/wiki/Storage</u> ²Source – EDSFF.org. <u>https://edsffspec.org/edsff-resources/</u> ³Source – Intel. 256TB = 32 drives in 1U x 8TB Intel[®] SSD DC P4510. 1PB = 32 drives in 1U x 32 TB Intel[®] SSD DC P4510. 32TB drive available at a later date. *Other names and brands may be claimed as the property of others.



Intel[®] Storage and Memory Innovations Building Blocks for Next Generation OCP Platforms







Appendix

- Most responsive SSD. Responsiveness defined as average read latency measured at queue depth 1 during 4k random write workload. Measured using FIO 2.15. Common configuration Intel 2U Server System, OS CentOS 7.2, kernel 3.10.0-327.el7.x86_64, CPU 2 x Intel® Xeon® E5-2699 v4 @ 2.20GHz (22 cores), RAM 396GB DDR @ 2133MHz. Intel drives evaluated Intel® Optane™ SSD DC P4800X 375GB and Intel® SSD DC P3700 1600GB. Samsung drives evaluated Samsung* SSD PM1725a, Samsung* SSD PM1725, Samsung* PM963, Samsung* PM953. Micron drive evaluated Micron* 9100 PCIe* NVMe* SSD. Toshiba drives evaluated Toshiba* ZD6300. Test QD1 Random Read 4K latency, QD1 Random RW 4K 70% Read latency, QD1 Random Write 4K latency using fio-2.15.
- 2. Breakthrough performance. Common Configuration Intel 2U Server System, OS CentOS 7.2, kernel 3.10.0-327.el7.x86_64, CPU 2 x Intel® Xeon® E5-2699 v4 @ 2.20GHz (22 cores), RAM 396GB DDR @ 2133MHz. Configuration Intel® Optane™ SSD DC P4800X 375GB and Intel® SSD DC P3700 1600GB. Performance measured under 4K 70-30 workload at QD1-16 using fio-2.15.
- 3. Predictably fast service. Common Configuration Intel 2U Server System, OS CentOS 7.2, kernel 3.10.0-327.el7.x86_64, CPU 2 x Intel® Xeon® E5-2699 v4 @ 2.20GHz (22 cores), RAM 396GB DDR @ 2133MHz. Configuration – Intel® Optane[™] SSD DC P4800X 375GB and Intel® SSD DC P3700 1600GB. QoS – measures 99% QoS under 4K 70-30 workload at QD1 using fio-2.15.
- 4. Responsive under load. Responsiveness defined as average read latency measured at queue depth 1 during 4k random write workload. Measured using FIO 2.15. Common Configuration Intel 2U Server System, OS CentOS 7.2, kernel 3.10.0-327.el7.x86_64, CPU 2 x Intel® Xeon® E5-2699 v4 @ 2.20GHz (22 cores), RAM 396GB DDR @ 2133MHz. Configuration Intel® Optane™ SSD DC P4800X 375GB and Intel® SSD DC P3700 1600GB. Latency Average read latency measured at QD1 during 4K Random Write operations using fio-2.15.
- 5. 6x Faster. Source Alibaba-tested: Source document @ <u>http://mp.weixin.qq.com/s?_biz=MzA4NjI4MzM4MQ==&mid=2660194350&idx=2&sn=7b937d463e0f28888a0ce07c31fd9007&chksm=84b0fd34b3c7742289b89bb09632f41d6a17646a626e ce8ceeefeac2815db3e87f3af9955feb&mpshare=1&scene=5&srcid=0921yeW6qPdiNB9MS8Vu5N6i#rd.</u>
- 6. VRoC Performance: Measured data compared to public announcement on HW RAID. Hardware RAID claim of 1.7M IOPS based on this http://investors.broadcom.com/phoenix.zhtml?c=203541&p=irol-newsArticle&id=2262535. Intel® VROC measured 2.4M IOPS. System configuration: Wolf Pass Silver platform, Intel® Xeon® 8170 Series Processors, 26 cores@ 2.1GHz, 192GB RAM, BIOS Version: SE5C620.86B.0X.01.0107.122220170349, BIOS Release Date: 12/22/2017. OS: Red Hat Enterprise Linux 7.3, 4x Intel® SSD DC P4510 2TB, drive firmware: VDV10120. BIOS: Hyper-threading enabled, Turbo/SpeedStep enabled, Package C-state set to "C6(non retention state)", processor C6 set to enabled, P-states set to default . RAID Tested: Intel® VROC-5.3 Workload Generator: FIO version- 3.2, RANDOM: Workers-16, IOdepth-256, No Filesystem, CPU Affinitized.
- 7. Intel® VROC vs. HW RAID price delta. RAID card price \$846. <u>https://www.newegg.com/Product/Product.aspx?ltem=9SIA24G6DK5238&cm_re=RSP3TD160F-_-1B4-008A-00135-_-</u> Product. Intel® VROC MSRP \$249
- 8. Open source RAID. RAID 0, 1, 5, 6, 10 support available on Red Hat Enterprise Linux 7.3* and Linux 7.4*. Intel UEFI drivers required for bootable RAID and enclosure management support.

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DCP Summ